

Snapdragon 820 - Technology and Traction

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Snapdragon roadmap drives new experiences



Snapdragon 820 is ideal for mobile VR

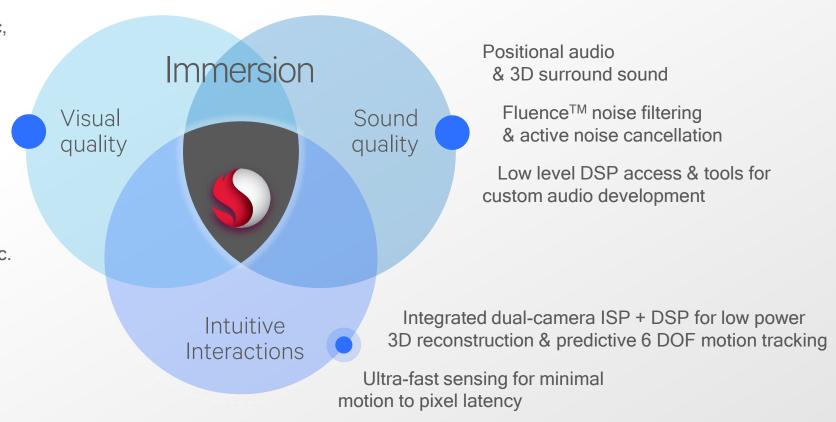
Designed to meet the VR processing demands within the thermal and power constraints

Smooth, 3D stereoscopic, image rendering, & support for the latest GPU APIs

Low power 360° 4K HEVC video decoding & display at 60 FPS

Qualcomm® TruPalette™ display gamut mapping, color enhancement, etc.

Qualcomm® EcoPix™ compression, variable refresh, etc.



Adreno Visual Processing

Qualcomm Spectra ISP

Hexagon DSP

Zeroth

Qualcomm Agstic™ audio

FastCV™ SDK

Snapdragon tools

MWC 2016 Recap

Snapdragon 820 Momentum

Snapdragon 820 in virtually every flagship device





"Qualcomm back inside Samsung's flagship phones" The San Diego Hnion-Tribune.

"Xiaomi's Mi 5 Launch Event a Giant Qualcomm Lovefest"

"Qualcomm is back with a vengeance. Welcome to Snapdragon World Congress"

"Xiaomi's 'most beautiful' flagship rocks a Snapdragon 820"





"5 Reasons To Buy The LG G5"



"Qualcomm: The Biggest Winner Of MWC 2016"



Expanding the Snapdragon platform

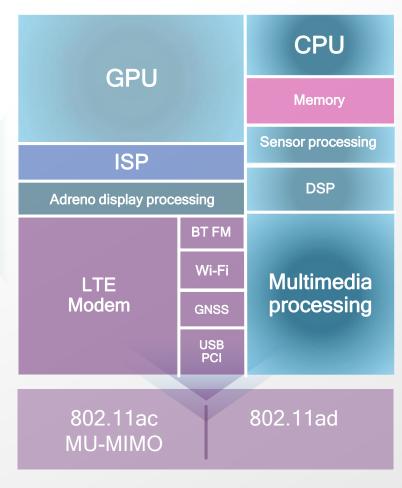
Increases differentiation and revenue opportunities

BOM integration

Quick Charge

Power Sensor Hub
interface Fingerprint

Speaker amp Codec



End-to-end design

Filters RF
Transceiver

Power
Amplifier Switch

Envelope
Tracker Tuner

Tri-band Wi-Fi

Snapdragon X12 LTE Modem

Up to 600 Mbps - Cat 12 DL

via 3x20MHz CA and 256-QAM, support for 4x4 MIMO

Up to 150 Mbps - Cat 13 UL

via 2x20MHz CA and 64-QAM

Multi-gigabit, Tri-Band Wi-Fi (2.4, 5 and 60GHz)

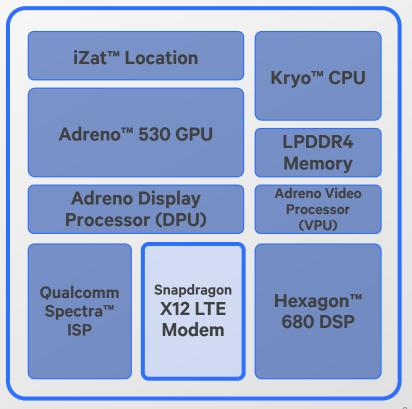
With 802.11ac 2x2 MU-MIMO and 802.11ad

Next-gen Calling – Enhanced mobility + quality

Smart Wi-Fi calling, Ultra HD voice

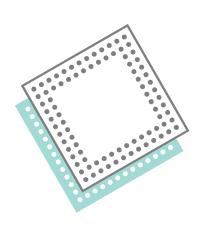


Qualcomm® Snapdragon™ 820 Processor



Kryo CPU

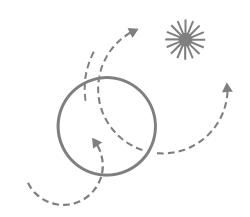
Custom 64-bit
CPU architecture



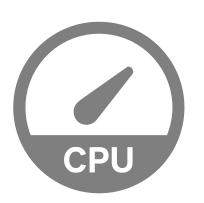
Up to 2x Better performance*
2X Lower power*



14nm FinFET process technology



Quad core CPU up to 2.2GHz





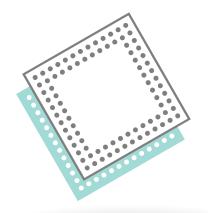


Hexagon 680 DSP

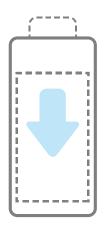
Core technical benefits

New Hexagon

Media coprocessing and computer vision



3x better performance* 10X lower power



Integrated Sensor Core

Low power island for always-on processing









Introducing



- 4X faster than conventional charging
- > 35% more efficient than Quick Charge 2.0
- #1 fast charging solution
- Connector agnostic

Snapdragon Sense ID fingerprint technology

Mobile Industry's FIRST ultrasonic fingerprint technology

Easier & More Reliable User Experience

Scans through:

- Common contaminants
- Glass (up to 400 μm)
- Metal (up to 400 μ m)





More Secure

- Detailed 3D map
- Liveness detection
- Based in hardware
- On-device processing

End-to-end solution

- Custom ultrasonic ASIC
- Integrated with FIDO UAF biometric protocol
- Algorithms managed by SecureMSM technology













Expected in commercial devices 2H 2015

Snapdragon Sense ID

Accuracy and consistency



Improved user experience by consistently scanning through various contaminants



Snapdragon

810 Processor

Cortex A53/A57

Custom Kryo CPU

Adreno 430

Adreno 530

Hexagon v56

Hexagon 680

4K30 8-bit

4K60 10-bit

X10 LTE Cat 10

X12 LTE Cat 12/13

Dual-ISP 20MP ZSL

Spectra ISP 28MP

ZSL

802.11ac | 802.11ad 60GHz

Display

Intra-core Compression compression with **UBWC**

> Low Power Island (NEW)



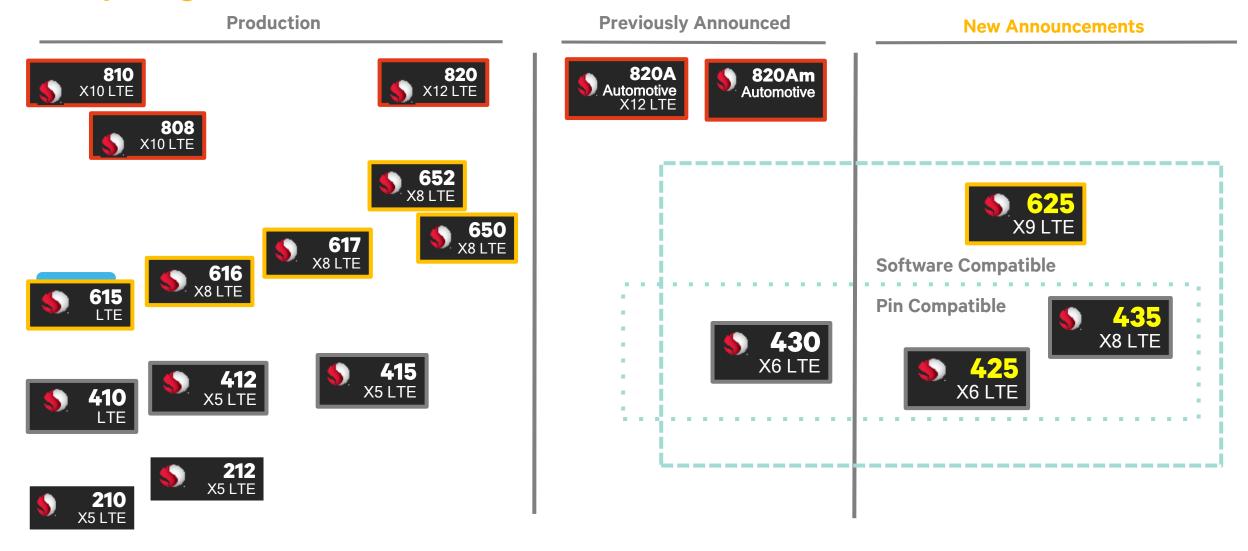


Snapdragon

820Processor

Roadmap

Snapdragon Announcements



Adjacent opportunities transformed by mobile





Mobile compute







Networking

Adjacent opportunities transformed by mobile

Auto

Mobile experiences on car displays

Vehicle-2-Cloud connectivity

Mobile compute

Smartphone changing productivity

Cloud experience driving always on connectivity

All-day computing



IoT

Connectivity everywhere and smart processing

Mobile ecosystem scale

Smartphone as IoT remote control

Networking

Integrated gateway hub for the home or enterprise

Wireless video defining use cases

LTE and Wi-Fi convergence

Thank you

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